P-Channel 60-V (D-S) MOSFET

GENERAL DESCRIPTION

The ME4947 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching , and low in-line power loss are needed in a very small outline surface mount package.

FEATURES

- $R_{DS(ON)} \leqq 72m\Omega @ V_{GS}=-10V$
- $R_{DS(ON)} \leqq 94m\Omega @ V_{GS}=-4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

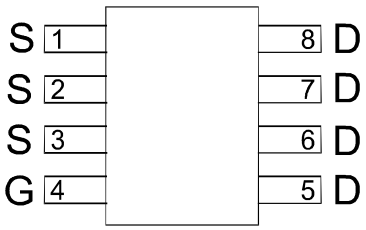
APPLICATIONS

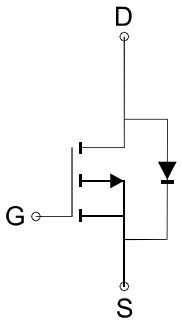
- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

PIN CONFIGURATION

(SOP-8)

Top View





P-Channel MOSFET

Ordering Information: ME4947 (Pb-free)

ME4947-G (Green product-Halogen free)

Absolute Maximum Ratings (T_A=25℃ Unless Otherwise Noted)

Parameter		Symbol	Steady State	Unit
Drain-Source Voltage		V_{DSS}	-60	V
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current(Tj=150℃)	T_A=25℃	I_D	-4.4	A
	T_A=70℃		-3.5	
Pulsed Drain Current		I_{DM}	-18	A
Maximum Power Dissipation	T_A=25℃	P_D	2.5	W
	T_A=70℃		1.6	
Operating Junction Temperature		T_J	-55 to 150	℃
Thermal Resistance-Junction to Ambient*		$R_{\theta JA}$	50	℃/W

*The device mounted on 1in^2 FR4 board with 2 oz copper

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Electrical Characteristics (T_A=25℃ Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0, I_D=-250μA	-60			V
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=-250μA	-1		-3	V
I_{GSS}	Gate Leakage Current	V_{DS}=0V, V_{GS}=±20V			±100	nA
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=-60V, V_{GS}=0V			-1	μA
$R_{DS(ON)}$	Drain-Source On-State Resistance	V_{GS}=-10V, I_D= -5A		60	72	mΩ
		V_{GS}=-4.5V, I_D= -4A		73	94	
V_{SD}	Diode Forward Voltage	I_S=-1A, V_{GS}=0V		-0.8	-1.2	V
DYNAMIC						
Qg	Total Gate Charge	V_{DS}=-30V, V_{GS}=-10V, I_D=-4A		23		nC
Qg	Total Gate Charge	V_{DS}=-30V, V_{GS}=-4.5V, I_D=-4A		11.4		
Qgs	Gate-Source Charge			5.1		
Qgd	Gate-Drain Charge			4.9		
Ciss	Input capacitance	V_{DS}=-15V, V_{GS}=0V, f=1MHz		1050		pF
Coss	Output Capacitance			76		
Crss	Reverse Transfer Capacitance			57		
$t_{d(on)}$	Turn-On Delay Time	V_{DD}=-30V, R_L=7.5Ω, V_{GEN}=-10V, R_G=3Ω		38		ns
t_r	Turn-On Rise Time			18		
$t_{d(off)}$	Turn-Off Delay Time			51		
t_f	Turn-On Fall Time			6		

Notes: a. Pulse test: pulse width≦ 300us, duty cycle≦ 2%,Guaranteed by design, not subject to production testing.

b. Matsuki reserves the right to improve product design, functions and reliability without notice.

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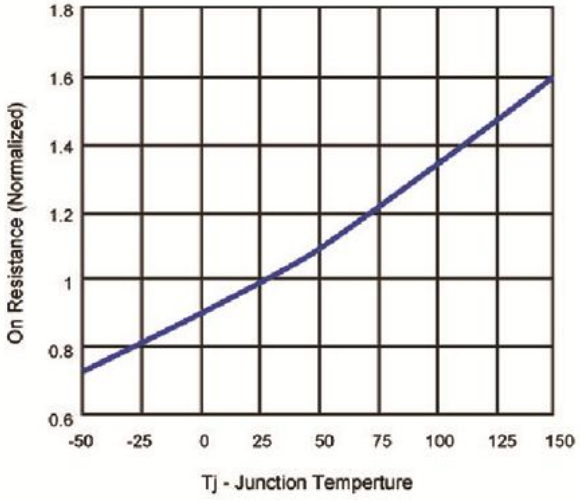
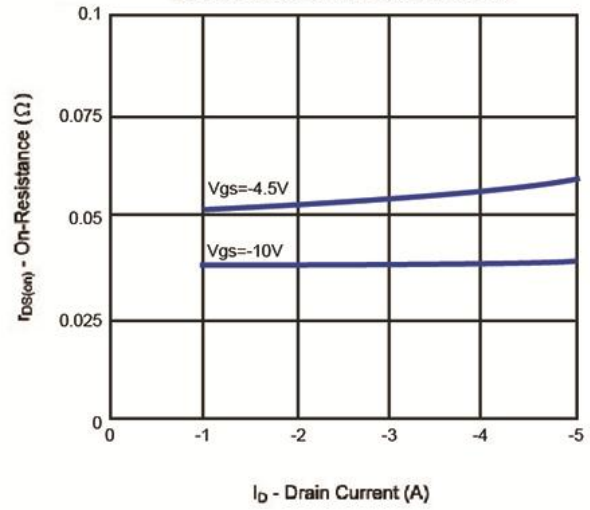
Typical Characteristics (T_J =25℃ Noted)

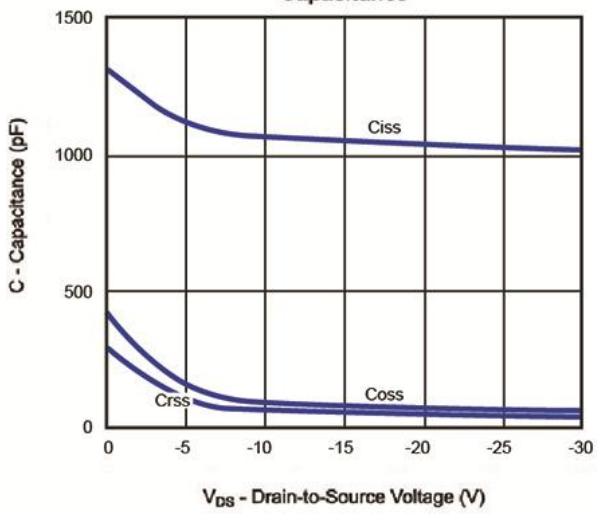
On Resistance vs. Junction Temperture



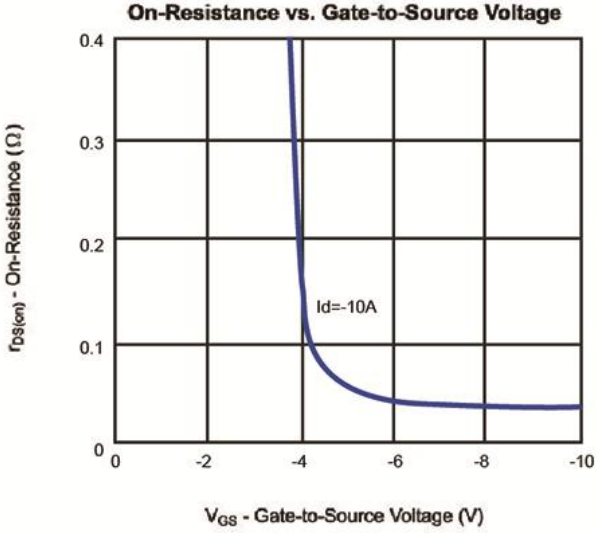
On-Resistance vs. Drain Current



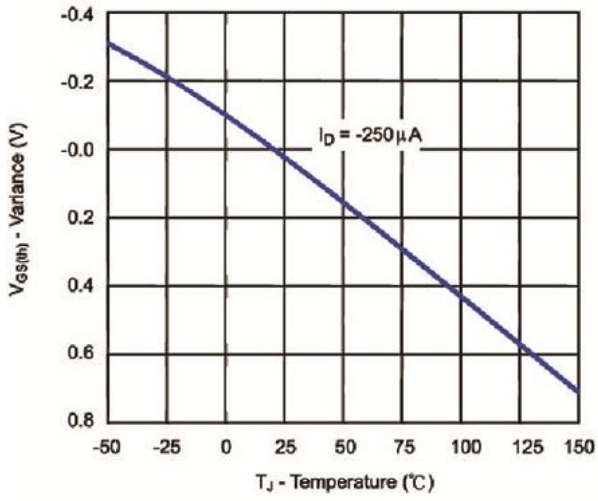
Capacitance



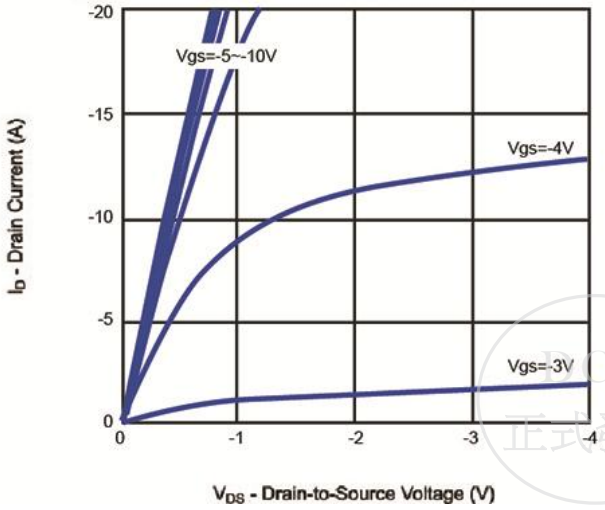
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



On-Region Characteristics



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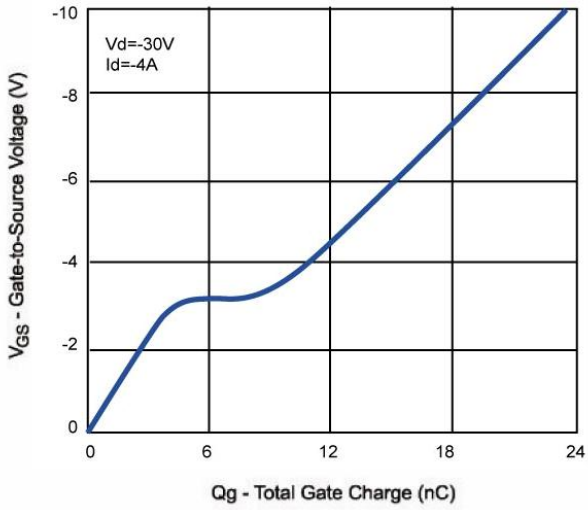
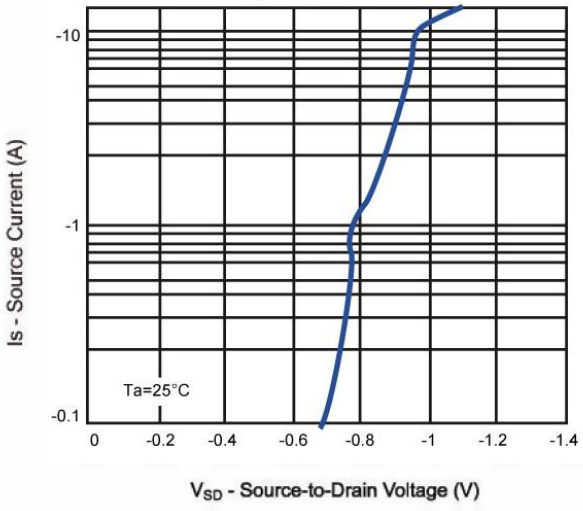
Typical Characteristics (T_J =25℃ Noted)

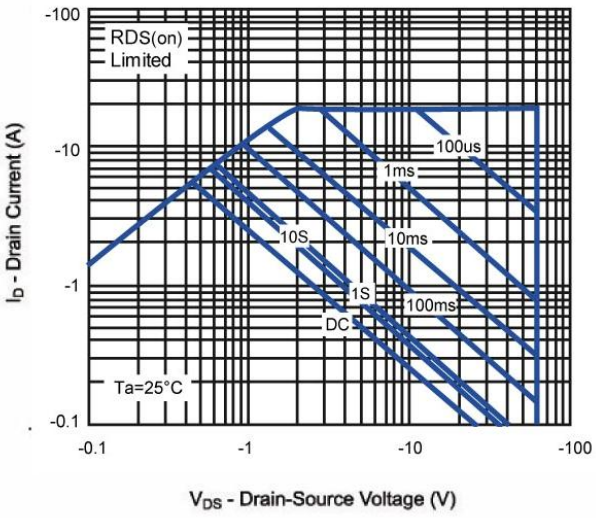
Gate Charge



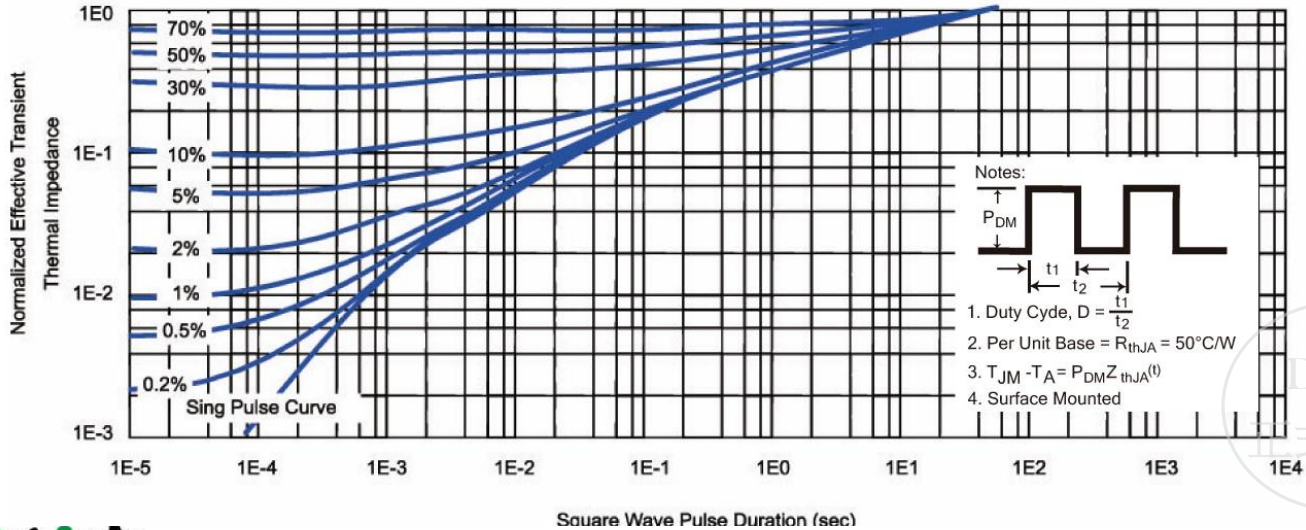
Body-diode characteristics



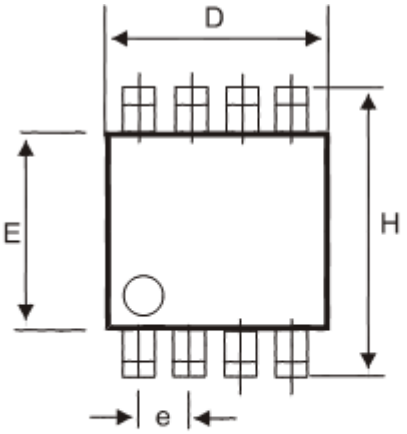
Maximum Forward Biased Safe Operating Area

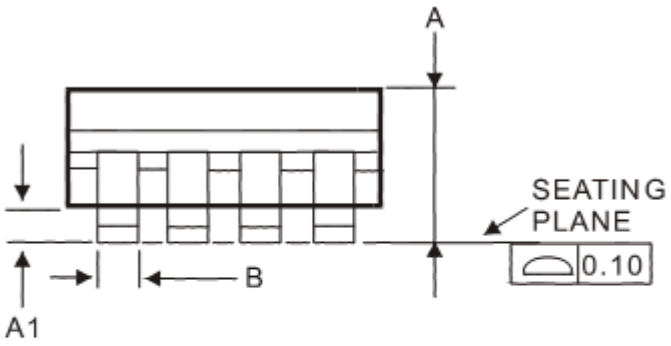


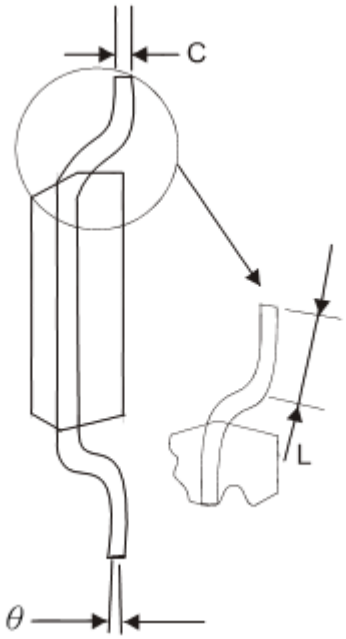
Normalized Thermal Transient Impedance, Junction-to-Ambient



SOP-8 Package Outline







Symbol	MILLIMETERS (mm)	
	MIN	MAX
A	1.35	1.75
A1	0.10	0.25
B	0.35	0.49
C	0.18	0.25
D	4.80	5.00
E	3.80	4.00
e	1.27 BSC	
H	5.80	6.20
L	0.40	1.25
θ	0°	7°